ASSOCIATION ELECTRONICS	CONNECTING INDUSTRIES International and Par	osition Dee PC, Bannockt n-American co	c laration ourn, Illinois. A opyright conve	Il rights reserved un ntions.	nder both	This docume level parts, t	ent is a declarat	tion of the encompare	ne substance asses all low	s within the er level mat	manufactur erials for wl	er listed in hich the m	tem. Note: nanufacture	if the item is an as er has engineering	ssembly with low responsibility.
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information					
upplier	Information														
Company name* Comp				Company unique ID			Unique ID Authority					Response Date*			
nsemi												2024-05-05			
Contact Na	me	Title - Contact]	Phone - Contact*					Email - Contact*				
Product-E	nv-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
uthorized	Representative*		Title - Representative]	Phone - Representative*				Email - Representative*				
roduct-E	nv-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item N 1N5359BG		Number Mfr Item Name				Effective Date	e Version Manufacturing Site		ring Site		Weight*	UOM	Unit Type	
			3G	ZEN SUR40 REG 5W 24V			2024-05-05 CNP		607.0		mg	Each			
Ianufac	turing Proccess Informa	tion													
r	Terminal Plating / Grid Array Material		Ferminal Base Alloy J-STD-020 M		-STD-020 MSI	L Rating	Peak Process Body Temperat		ure Max Time at Peak Tem		Temperat	ure Num	ber of Reflow Cy	cles	
Matte Tin (Sn) - annealed (U Alloy NA			0 C		30		secon	ds 3					
omments															
or more in	nformation regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).										
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).								
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature	astislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.5	mg	Supplier	Silicon (Si)	7440-21-3		4.5	mg
Die Attach Solder	21.29	mg	Supplier	Silver (Ag)	7440-22-4		0.5323	mg
			А	Lead (Pb)	7439-92-1	7a	19.6933	mg
			Supplier	Tin (Sn)	7440-31-5		1.0645	mg
Lead Frame	333.62	mg	В	Nickel (Ni)	7440-02-0		3.6698	mg
			Supplier	Copper (Cu)	7440-50-8		329.9502	mg
Mold Compound-Black	239.19	mg		Metal Hydroxide	proprietary data		11.9595	mg
			Supplier	Carbon Black (C)	1333-86-4		2.3919	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		179.3925	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		23.919	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		21.5271	mg
Plating	8.4	mg	Supplier	Tin (Sn)	7440-31-5		8.4	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3